

Fair-Rite P/N **2761015112**

61 Material Grade

Nominal Chemical Composition

<u>Compound</u>	<u>CAS Number</u>	<u>wt %</u>	Wt of core (g)= 0.219	Compound Weight (g) Breakdown of 61 Material
Fe2O3	1309-37-1	72	0.1577	
ZnO	1314-13-2	13	0.0285	
NiO	1313-99-1	11	0.0241	
MnO	1344-43-0	2	0.0044	
CuO	1317-38-0	1	0.0022	
CoO	1307-96-6	1	0.0022	

Pb- Free Plated Round Cu Wire

<u>Element</u>	<u>CAS Number</u>	<u>wt%</u>	Wt of wire (g)= 0.181	Element Weight (g) Breakdown of Pb- Free Plated Round Cu Wire
Cu	7440-50-8	94.4	0.17086	
Plating:				
Ni	7440-02-0	0.9	0.00163	
Sn	7440-31-5	4.7	0.00851	

Calculated Maximum Levels of RoHS Restricted Substances Present in 61 Material Grade

<u>Impurity Substance</u>	<u>RoHS Threshold (ppm)</u>	<u>ppm</u>	Wt of core (g)= 0.219	RoHS Impurity Substance Weight (g) Breakdown of 61 Material
Cr+6	1000	0.00	0	
Cd	100	3.70	8.103E-07	
Hg	1000	0.10	2.19E-08	
Pb	1000	7.00	0.000001533	
PBB	1000	0.00	0	
PBDE	1000	0.00	0	

Supporting notes:

1. P/N 2761015112 consists of:
 - a core 61 Material Grade
 - b wire Pb- Free Plated Round Cu Wire
2. Moisture Sensitivity Level (MSL)= 1
3. Max Reflow Temp= 260 degC
4. Max Time at Max Reflow Temp= 40 sec
5. RoHS 6/6 Compliant Terminations/ Wire are backwards compatible with standard Soldering Processes
6. RoHS Conversion Date= 1/1/2005
RoHS Compliance Marking is
7. Contained on Shipping Labels